



### 5V μP Power Supply Monitor and Reset Circuit

### **General Description**

The ASM1232LP/LPS is a fully integrated microprocessor supervisor. It can halt and restart a "hung-up" microprocessor, restart a microprocessor after a power failure. It has a watchdog timer and external reset override.

A precision temperature-compensated reference and comparator circuits monitor the 5V,  $V_{CC}$  input voltage status. During power-up or when the  $V_{CC}$  power supply falls outside selectable tolerance limits, both RESET and  $\overline{RESET}$  become active. When  $V_{CC}$  rises above the threshold voltage, the reset signals remain active for an additional 250ms minimum, allowing the power supply and system microprocessor to stabilize. The trip point tolerance signal, TOL, selects the trip level tolerance to be either 5% or 10%.

Each device has both a push-pull, active HIGH reset output and an open drain active LOW reset output. A debounced manual reset input, PBRST, activates the reset outputs for a minimum period of 250ms.

There is a watchdog timer to stop and restart a microprocessor that is "hung-up". The watchdog timeouts periods are selectable: 150ms, 610ms and 1200ms. If the  $\overline{\text{ST}}$  input is not strobed LOW before the time-out period expires, a reset is generated.

Devices are available in 8-pin DIP, 16-pin SO and compact 8-pin MicroSO packages.

#### **Key Features**

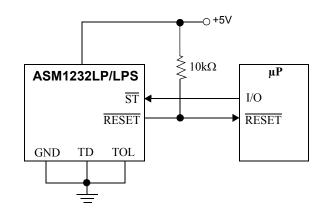
- 5V supply monitor
- Selectable watchdog period
- Debounce manual push-button reset input
- Precision temperature-compensated voltage reference and comparator.
- Power-up, power-down and brown out detection
- 250ms minimum reset time
- Active LOW open drain reset output and active HIGH push-pull output
- Selectable trip point tolerance: 5% or 10%

- Low-cost surface mount packages: 8-pin/16-pin SO, 8-pin
   DIP and 8-pin Micro SO packages
- Wide operating temperature -40°C to +85°C (N suffixed devices)

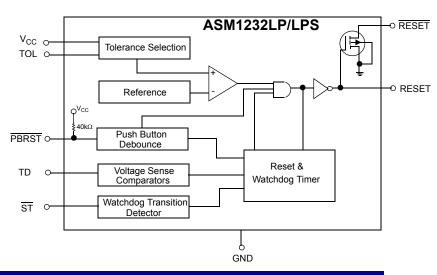
#### **Applications**

- · Microprocessor Systems
- Computers
- Controllers
- Portable Equipment
- Intelligent Instuments
- Automotive Systems

### **Typical Operating Circuit**



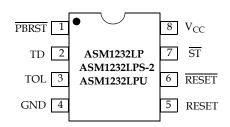
#### **Block Diagram**

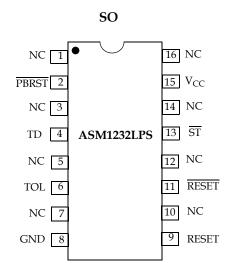




# **Pin Configuration**

### DIP/SO/MicroSO





# **Pin Description**

Pin # 8-Pin Package	Pin # 16-Pin Package	Pin Name	Function
1	2	PBRST	Debounced manual pushbutton RESET input.
2	4	TD	Watchdog time delay selection. ( $t_{TD}$ = 150ms for TD = GND, $t_{TD}$ = 610ms for TD=Open, and $t_{TD}$ = 1200ms for TD = $V_{CC}$ ).
3	6	TOL	Selects 5% (TOL connected to GND) or 10% (TOL connected to $V_{\rm CC}$ ) trip point tolerance.
4	8	GND	Ground.
5	9	RESET	Active HIGH reset output. RESET is active:  1. If V <sub>CC</sub> falls below the reset voltage trip point.  2. If PBRST is LOW.  3. If ST is not strobed LOW before the timeout period set by TD expires.  4. During power-up.
6	11	RESET	Active LOW reset output. (See RESET).
7	13	ST	Strobe input.
8	15	V <sub>CC</sub>	5V power.
-	1,3,5,7, 10,12,14,16	NC	No internal connection.



#### **Detailed Description**

The ASM1232LP/LPS monitors the microprocessor or microcontroller power supply and generates reset signal, both active HIGH and Active LOW, that halt processor operation whenever the power supply voltage levels are outside a predetermined tolerance.

#### RESET and RESET outputs

RESET is an active HIGH signal developed by a CMOS push-pull output stage and is the logical opposite to RESET.

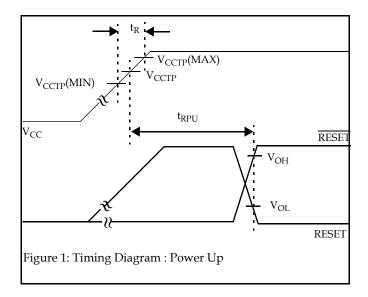
RESET is an active LOW signal. It is developed with an open drain driver. A pull up resistor of typical value  $10k\Omega$  to  $50k\Omega$  is required to connect with the output.

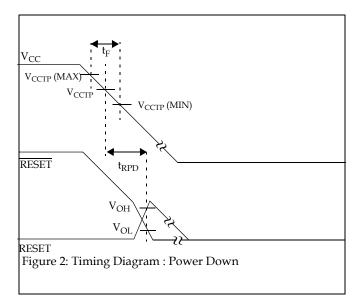
#### **Trip Point Tolerance Selection**

The TOL input is used to determine the level  $V_{CC}$  can vary below 5V without asserting a reset. With TOL conected to  $V_{CC}$ , RESET and  $\overline{\text{RESET}}$  become active whenever  $V_{CC}$  falls below 4.5V. RESET and  $\overline{\text{RESET}}$  become active when the  $V_{CC}$  falls below 4.75V if TOL is connected to ground.

After  $V_{CC}$  has risen above the trip point set by TOL, RESET and  $\overline{RESET}$  remain active for a minimum time period of 250ms. On power-down, once  $V_{CC}$  falls below the reset threshold RESET stays LOW and is guaranteed to be 0.4V or less until  $V_{CC}$  drops below 1.2V. The active HIGH reset signal is valid down to a  $V_{CC}$  level of 1.2V also.

Tolerance Select	Tolerance	TRIP Point Voltage (V)		
Oelect		Min	Nom	Max
TOL = V <sub>CC</sub>	10%	4.25	4.37	4.49
TOL = GND	5%	4.5	4.62	4.74





#### **Application Information**

#### **Manual Reset Operation**

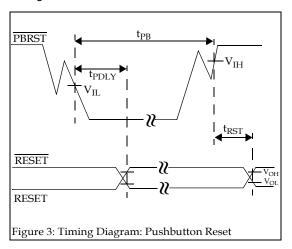
Push-button switch input,  $\overline{PBRST}$ , allows the user to override the internal trip point detection circuits and issue reset signals. The pushbutton input is debounced and is pulled HIGH through an internal  $40k\Omega$  resistor.

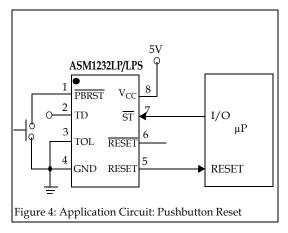


When  $\overline{PBRST}$  is held LOW for the minimum time  $t_{PB}$ , both resets become active and remain active for a minimum time period of 250ms after  $\overline{PBRST}$  returns HIGH.

The debounced input is guaranteed to recognize pulses greater than 20ms. No external pull-up resistor is required, since  $\overline{PBRST}$  is pulled HIGH by an internal  $40k\Omega$  resistor.

The PBRST can be driven from a TTL or CMOS logic line or shorted to ground with a mechanical switch.

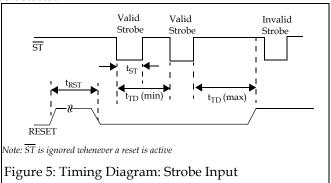




## Watchdog Timer and ST Input

A watchdog timer stops and restarts a microprocessor that is "hung-up". The  $\mu P$  must toggle the  $\overline{ST}$  input within a set period (as selectable through TD input) to verify proper software execution. If the  $\overline{ST}$  is not toggled low within the minimum timeout period, reset signals become active. In

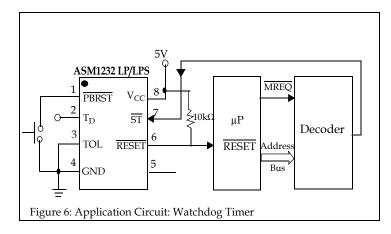
power-up after the supply voltage returns to an in-tolerance condition, the reset signal remains active for 250ms minimum, allowing the power supply and system microprocessor to stabilize.  $\overline{\text{ST}}$  pulses as short as 20ns can be detected.



Timeouts periods of approximately 150ms, 610ms or 1,200ms are selected through the TD pin.

TD Voltage level	Watchdog Time-out Period (ms)				
	Min Nom Max				
GND	62.5	150	250		
Floating	250	610	1000		
V <sub>CC</sub>	500	1200	2000		

The watchdog timer can not be disabled. It must be strobed with a high-to-low transition to avoid watchdog timeout and reset.





# **Absolute Maximum Ratings**

Parameter	Min	Max	Unit
Voltage on V <sub>CC</sub>	-0.5	7	V
Voltage on ST, TD	-0.5	V <sub>CC</sub> + 0.5	V
Voltage on PBRST, RESET, RESET	-0.5	V <sub>CC</sub> + 0.5	V
Operating Temperature Range (N suffixed devices)	-40	+85	°C
Operating Temperature Range (others)	0	70	°C
Soldering Temperature (for 10 sec)		+260	°C
Storage Temperature	-55	+125	°C
ESD rating  HBM  MM		2 200	KV V

#### Note

#### **DC Electrical Characteristics**

Unless otherwise stated, 4.5V <=  $V_{CC}$ <= 5.5V and over the operating temperature range of 0°C to 70°C (-40°C to +85°C. for N devices). All voltages are referenced to ground.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	V <sub>CC</sub>		4.5		5.5	V
ST and PBRST Input High Level	V <sub>IH</sub>		2		V <sub>CC</sub> + 0.3	V
ST and PBRST Input Low Level	V <sub>IL</sub>		-0.3		0.8	V
V <sub>CC</sub> Trip Point (T <sub>OL</sub> = GND)	V <sub>CCTP</sub>		4.50	4.62	4.74	V
V <sub>CC</sub> Trip Point (T <sub>OL</sub> = V <sub>CC</sub> )	V <sub>CCTP</sub>		4.25	4.37	4.49	V
Watchdog Timeout Period	t <sub>TD</sub>	T <sub>D</sub> = GND	62.5	150	250	ms
Watchdog Timeout Period	t <sub>TD</sub>	T <sub>D</sub> = VCC	500	1200	2000	ms
Watchdog Timeout Period	t <sub>TD</sub>	T <sub>D</sub> Floating	250	610	1000	ms
Output Voltage	V <sub>OH</sub>	I=-500μA, Note 3	V <sub>CC</sub> - 0.5	V <sub>CC</sub> - 0.1		V
Output Current	I <sub>OH</sub>	Output = 2.4V, Note 2	-8	-10		mA
Output Current	I <sub>OL</sub>	Output = 0.4V	10			mA

<sup>1.</sup> Voltages are measured with respect to ground

<sup>2.</sup> These are stress ratings only and functional implication is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.



Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input Leakage	I <sub>IL</sub>	Note 1	-1.0		1.0	μA
RESET Low Level	V <sub>OL</sub>	Note 3			0.4	V
Internal Pull-up Resistor		Note 1		40		kΩ
Operating Current (CMOS)	I <sub>CC1</sub>				30	μA
Input Capacitance	C <sub>IN</sub>				5	pF
Output Capacitance	C <sub>OUT</sub>				10	pF
PBRST Manual Reset Minimum Low Time	t <sub>PB</sub>	PBRST = V <sub>IL</sub>	20			ms
Reset Active Time	t <sub>RST</sub>		250	610	1000	ms
ST Pulse Width	t <sub>ST</sub>	Note 4	20			ns
V <sub>CC</sub> Fail Detect to RESET or RESET	t <sub>RPD</sub>			5	8	μs
V <sub>CC</sub> Slew Rate	t <sub>F</sub>	4.75V to 4.25V	300			μs
PBRST Stable LOW to RESET and RESET Active	t <sub>PDLY</sub>				20	ms
V <sub>CC</sub> Detect to RESET or RESET inactive	t <sub>RPU</sub>	t <sub>RISE</sub> = 5µs	250	610	1000	ms
V <sub>CC</sub> Slew Rate	t <sub>R</sub>	4.25V to 4.75V	0			ns

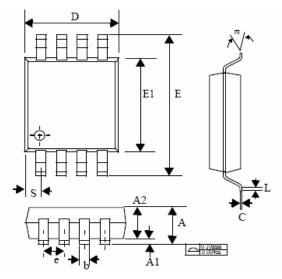
#### Notes

- 1.  $\overline{\mbox{PBRST}}$  is internally  $\mbox{ pulled HIGH to V}_{\mbox{CC}}$  through a nominal 40k $\!\Omega$  resistor.
- 2. RESET is an open drain output.
- 3. RESET remains within 0.5V of  $V_{CC}$  on power-down until  $V_{CC}$  falls below 2V. RESET remains within 0.5V of ground on power-down until  $V_{CC}$  falls below 2.0V.
- 4. Must not exceed the minimum watchdog time-out period  $(t_{TD})$ . The watchdogcircuit cannot be disabled. To avoid a reset,  $\overline{ST}$  must be strobed.

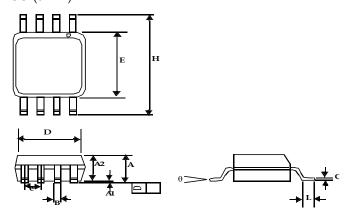


# **Package Information**

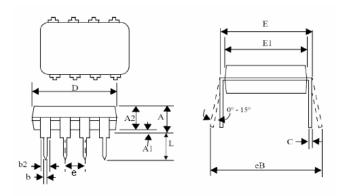
## MicroSO (8-Pin)



SO (8-Pin)



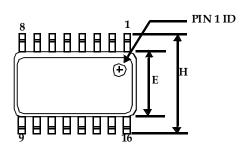
Plastic DIP (8-Pin)

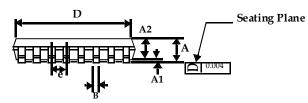


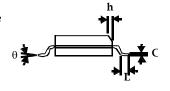
	Incl	hes	Millimeteres		
	Min	Max	Min	Max	
	171111	MicroSO (8-		Wax	
A	0.032	0.044	0.81	1.10	
A1	0.002	0.006	0.01	0.15	
A1 A2	0.002	0.008	0.05	0.15	
b	0.030			BSC	
_					
С	0.004	0.008	0.10	0.20	
D	0.114	0.122	2.90	3.10	
e	0.0256		0.65		
E	0.184	0.200	4.67	5.08	
E1	0.114	0.122	2.90	3.10	
L	0.016	0.026	0.41	0.66	
S	0.0206		0.52		
а	0°	6°	0°	6°	
		SO (8-Pir			
Α	0.053	0.069	1.35	1.75	
A1	0.004	0.010	0.10	0.25	
A2	0.049	0.059	1.25	1.50	
В	0.012	0.020	0.31	0.51	
С	0.007	0.010	0.18	0.25	
D	0.193	BSC	4.90	BSC	
E	0.154	BSC	3.91	BSC	
е	0.050	BSC	1.27	BSC	
Н	0.236	BSC	6.00	BSC	
L	0.016	0.050	0.41	1.27	
θ	0°	8°	0°	8°	
		Plastic DIP (8	B-Pin)		
Α	-	0.210	-	5.33	
A1	0.015	-	0.38	-	
A2	0.115	0.195	2.92	4.95	
b	0.014	0.022	0.36	0.56	
b2	0.045	0.070	1.14	1.78	
С	0.008	0.014	0.20	0.36	
D	0.355	0.400	9.02	10.16	
Е	0.300	0.325	7.62	8.26	
E1	0.240	0.280	6.10	7.11	
е	0.100	BSC	2.54	BSC	
еВ	-	0.430	-	10.92	
L	0.115	0.150	2.92	3.81	



# SO (16-Pin)







	SO (16-Pin)*				
	Inches		Millimeter		
	Min	Max	Min	Max	
А	0.053	0.069	1.35	1.75	
A1	0.004	0.010	0.10	0.25	
A2	0.049	0.059	1.25	1.50	
В	0.013	0.022	0.33	0.53	
С	0.008	0.012	0.19	0.27	
D	0.386	0.394	9.80	10.01	
E	0.150	0.157	3.80	4.00	
е	0.050 BSC		1.27 BS	С	
Н	0.228	0.244	5.80	6.20	
h	0.010	0.016	0.25	0.41	
L	0.016	0.035	0.40	0.89	
θ	0°	8°	0°	8°	

<sup>\*</sup> JEDEC Drawing MS-013AA



# **Ordering Information**

Part Number	Package	Operating Temperature Range	Maximum Supply Current (μΑ)	Voltage Monitoring Application	Package Marking		
TIN-LEAD DEVICES							
ASM1232LP	8L PDIP	0°C to +70°C	30	5V	ASM1232LP		
ASM1232LPN	8L PDIP	-40° C to +85°C	30	5V	ASM1232LPN		
ASM1232LPS	16L SOIC	0°C to +70°C	30	5V	ASM1232LPS		
ASM1232LPS-2	8L SOIC	0°C to +70° C	30	5V	ASM1232LPS-2		
ASM1232LPSN	16L SOIC	-40°C to +85°C	30	5V	ASM1232LPSN		
ASM1232LPSN-2	8L SOIC	-40°C to +85°C	30	5V	ASM1232LPSN-2		
ASM1232LPU	8L MSOP	0°C to +70°C	30	5V	ASM1232LP		
ASM1232LPUN	8L MSOP	-40°C to +85°C	30	5V	ASM1232LPN		
LEAD FREE DEVICES	S						
ASM1232LPF	8L PDIP	0°C to +70°C	30	5V	ASM1232LPF		
ASM1232LPNF	8L PDIP	-40°C to +85°C	30	5V	ASM1232LPNF		
ASM1232LPS-2F	8L SOIC	0°C to +70°C	30	5V	ASM1232LPS-2F		
ASM1232LPSF	16L SOIC	0°C to +70°C	30	5V	ASM1232LPSF		
ASM1232LPSN-2F	8L SOIC	-40°C to +85°C	30	5V	ASM1232LPSN-2F		
ASM1232LPSNF	16L SOIC	-40°C to +85°C	30	5V	ASM1232LPSNF		
ASM1232LPUF	8L MSOP	0°C to +70°C	30	5V	ASM1232LPF		
ASM1232LPUNF	8L MSOP	-40°C to +85°C	30	5V	ASM1232LPNF		





Alliance Semiconductor Corporation 2575, Augustine Drive, Santa Clara, CA 95054 Tel: 408 - 855 - 4900

Fax: 408 - 855 - 4999

www.alsc.com

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